

Datasheet revision 1.0

Solder Wire SAC305 No-Clean with 2.0% Flux Core 1lb Spool

Product Highlights No-Clean Synthetic Flux Core The clear, non-corrosive, non-conductive residue is meant to be left on the board. 2.0% flux core Halogen content: None RoHS II and REACH compliant

| Sn96.5/Ag3.0/Cu0.5 |
|-----------------------|
| 0.031" (0.8mm) |
| No-Clean Synthetic |
| ROL0 |
| 217-220°C (423-428°F) |
| 1 lb spool |
| |

Test Results

| Test Requirement | Result |
|---|--|
| IPC-TM-650: 2.3.32 | L: No breakthrough |
| IPC-TM-650: 2.6.15 | L: No corrosion |
| IPC-TM-650: 2.3.28.1 | L: <0.5% |
| IPC-TM-650: 2.6.14.1 | L: <1 decade drop (No-clean) |
| IPC-TM-650: 2.6.3.7 | L: ≥100MΩ (No-clean) |
| IPC-TM-650: 3.4.2.5 | Clear and free from precipitation |
| Electronic Industry Citizenship Coalition (EICC) | Compliant |
| Articles 33 and 67 of Regulation (EC) No 1907/2006 | Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials |
| | IPC-TM-650: 2.3.32 IPC-TM-650: 2.6.15 IPC-TM-650: 2.3.28.1 IPC-TM-650: 2.6.14.1 IPC-TM-650: 2.6.3.7 IPC-TM-650: 3.4.2.5 Electronic Industry Citizenship Coalition (EICC) Articles 33 and 67 of Regulation (EC) |

Conforms to the following Industry Standards:J-STD-004B, Amendment 1 (Solder Fluxes):YesJ-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):YesRoHS 2 Directive 2011/65/EU:Yes